PHYSICAL INFRASTRUCTURE SYSTEMS

B. Copper Systems

C. Fiber **Optic** Systems

D. Power over Ethernet

E. Zone Cabling

Wireless

G. **Outlets**

Н. Media Distribution

Ι. **Physical** Infrastructure Management

J. Overhead & Underfloor Routing

Surface Raceway

Cabinets, Racks & Cable Managemen^a

M. **Grounding & Bonding**

> N. Industrial

0. Labeling & Identification

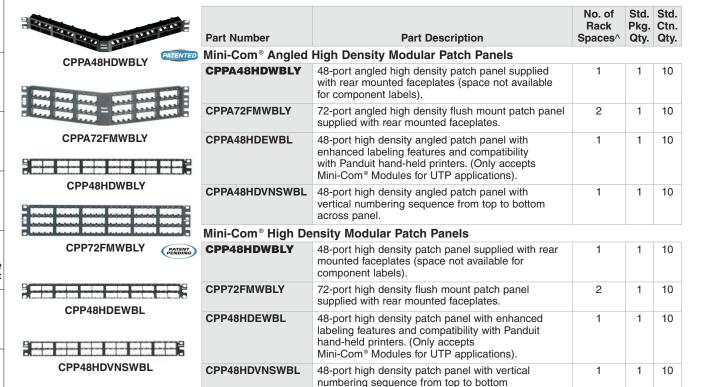
P. Cable Management Accessories

> 0. Index

Mini-Com® High Density Modular Patch Panels

- Accept Mini-Com® Modules for UTP, fiber optic, and audio/video, which snap in and out for easy moves, adds, and changes
- Conserve valuable rack space, but may be limited to specific modules (UTP)
- Pre-printed numbers above each port for easy identification

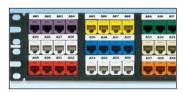
- Mount to standard EIA 19" racks or 23" racks with optional extender brackets
- Angled patch panels facilitate proper bend radius control and minimize the need for horizontal cable managers
- Enhanced label version of 48-port high density patch panels only accept UTP modules



^One rack space = 1.75" (44.45mm). M6 and #12-24 mounting screws included.

Component Labels for Mini-Com® High Density Modular Patch Panels

across panel.



Suggested Label Solutions for TIA/EIA-606-A Compliance				
Patch Panel Part Number	Laser/Ink Jet Desktop Printer Label	TDP43ME Thermal Transfer Desktop Printer Label	PanTher™ LS8E Hand-Held Printer Label	Cougar™ LS9 Hand-Held Printer Label
CPPA72FMWBLY CPP72FMWBLY	C261X030FJJ	C261X030YPT	C261X030FJC	T031X000FJC-BK

48-port high density patch panel layout does not allow space for component labels. For complete labeling solutions and product information, reference charts on pages O.1 - O.22 of SA-NCCB51.